



- 0 14 bar absolute pressure range
- High accuracy temperature measurement
- Integrated miniature pressure sensor module
- 4.75 mm x 4.25 mm
- Thin design of 1.6 mm
- Piezo-resistive silicon micro-machined sensor
- 6 coefficients for software compensation stored on-chip
- 16 bit ADC, sigma delta converter
- 3-wire serial interface
- 1 system clock line (32.768 kHz)
- Low voltage and low power consumption
- RoHS-compatible & Pb-free

## **DESCRIPTION**

The MS5562 is a SMD-hybrid device from MEAS Switzerland including a precision piezo-resistive pressure sensor and an ADC-Interface IC. It uses a three-wire serial interface for communication. The module dimensions of 4.75 mm x 4.25 mm and a height of only 1.6 mm allows for up-to-date SMD design. It provides a 16 bit data word from a pressure and temperature dependent voltage. The MS5562 is a low power, low voltage device with automatic power down (ON/OFF) switching. A 3-wire interface is used for all communications with a microcontroller.

## **FEATURES**

- Pressure resolution 1.2 mbar
- Operating temperature -40 °C to +85 °C
- Supply voltage 2.2 V to 3.6 V
- Low supply current, typ. 4 μA Standby current < 0.1 μA</li>
- ESD protected, HBM 4 kV

Mobile water measurement systems

**APPLICATIONS** 

## **BLOCK DIAGRAM**

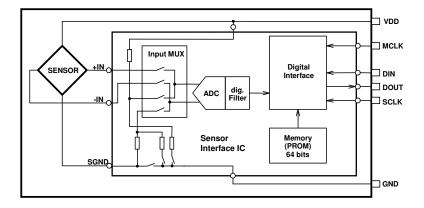


Fig. 1: Block diagram MS5562



## **PIN CONFIGURATION**

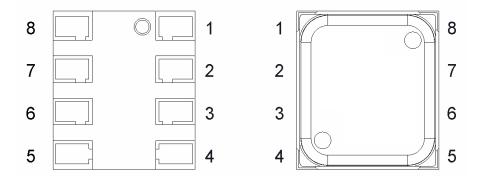


Fig. 2: Pin configuration of MS5562

Pin Name	Pin	Туре	Function
SCLK	1	I	Serial data clock
GND	2	G	Ground
PV (1)	3	N	Negative programming voltage
PEN (1)	4	1	Programming enable
VDD	5	Р	Positive supply voltage
MCLK	6	I	Master clock (32.768 kHz)
DIN	7	1	Serial data input
DOUT	8	0	Serial data output

## **NOTE**

1) Pin 3 (PV) and Pin 4 (PEN) are only used by the manufacturer for calibration purposes and should not be connected.

## **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Conditions	Min	Max	Unit	Notes
Supply voltage	VDD	Ta = 25 °C	-0.3	4	V	
Storage temperature	Ts		-40	+85	℃	1
Overpressure	Р	Ta = 25 ℃		30	bar	

## **NOTE**

1) Storage and operation in an environment of dry and non-corrosive gases.



## RECOMMENDED OPERATING CONDITIONS

(Ta = 25 °C, VDD = 3.0 V unless noted otherwise)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Operating pressure range	р		0		14	Bar
Supply voltage	VDD		2.2	3.0	3.6	V
Supply current,		VDD = 3.0 V				
average (1)	lavg			4		μΑ
during conversion (2)	I <sub>sc</sub>			1		mΑ
standby (no conversion)	I <sub>ss</sub>				0.1	μΑ
Current consumption into MCLK (3)		MCLK = 32.768 kHz			0.5	μΑ
Operating temperature range	Т		-40	+25	+85	℃
Conversion time	t <sub>conv</sub>	MCLK = 32.768 kHz			35	Ms
External clock signal (4)	MCLK		30.000	32.768	35.000	kHz
Duty cycle of MCLK			40/60	50/50	60/40	%
Serial data clock	SCLK				500	kHz

## NOTE

- 1) Under the assumption of one conversion every second. Conversion means either a pressure or a temperature measurement started by a command to the serial interface of MS5562.
- 2) During conversion the sensor will be switched on and off in order to reduce power consumption; the total on time within a conversion is about 2 ms.
- 3) This value can be reduced by switching off MCLK while MS5562 is in standby mode.
- 4) It is strongly recommended that a crystal oscillator be used because the device is sensitive to clock jitter. A square-wave form of the clock signal is a must.



## **ELECTRICAL CHARACTERISTICS**

## **DIGITAL INPUTS**

 $(T = -40 \, ^{\circ}C ... \, 85 \, ^{\circ}C, \, VDD = 2.2 \, V ... \, 3.6 \, V)$ 

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input High Voltage	V <sub>IH</sub>		80% VDD		100% VDD	V
Input Low Voltage	V <sub>IL</sub>		0% VDD		20% VDD	V
Signal Rise Time	t <sub>r</sub>			200		ns
Signal Fall Time	t <sub>f</sub>			200		ns

## **DIGITAL OUTPUTS**

 $(T = -40 \, ^{\circ}C ... \, 85 \, ^{\circ}C, \, VDD = 2.2 \, V ... \, 3.6 \, V)$ 

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output High Voltage	V <sub>OH</sub>	I <sub>source</sub> = 0.6 mA	80% VDD		100% VDD	V
Output Low Voltage	$V_{OL}$	$I_{sink} = 0.6 \text{ mA}$	0% VDD		20% VDD	V
Signal Rise Time	t <sub>r</sub>			200		ns
Signal Fall Time	t <sub>f</sub>			200		ns

## **AD-CONVERTER**

 $(T = -40 \, ^{\circ}\text{C} ... \, 85 \, ^{\circ}\text{C}, \, VDD = 2.2 \, V ... \, 3.6 \, V)$ 

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Resolution				16		Bit
Linear Range			4'000		40'000	LSB
Conversion Time		MCLK = 32.768 kHz			35	ms
INL		Within linear range	-5		+5	LSB



## PRESSURE OUTPUT CHARACTERISTICS

With the calibration data stored in the interface IC of the MS5562, the following characteristics can be achieved:

(VDD = 3.0 V unless noted otherwise)

Parameter	Conditions	Min	Тур	Max	Unit	Notes
Resolution			1.2		mbar	1
Absolute Progrum Assuracy	p = 0 3 bar	-15		+15	mbar	
Absolute Pressure Accuracy	p = 0 6bar	-30		+30	mbar	2
(Temperature range 0 +50 °C)	p = 0 14 bar	-150		+150	mbar	
Absolute Progrum Assuracy	p = 0 3 bar	-50		+50	mbar	
Absolute Pressure Accuracy (Temperature range 0 +85 °C)	p = 0 6bar	-140		+140	mbar	3
(Temperature range 0 +65 C)	p = 0 14 bar	-300		+300	mbar	
Long-term Stability	1 year		20			4
Maximum Error over Supply Voltage	VDD = 2.2 3.6 V	-16		16	mbar	

## **NOTES**

- 1) A stable pressure reading of the given resolution requires taking th average of 2 to 4 subsequent pressure values due to noise of the ADC.
- 2) Maximum error of pressure reading over the pressure range.
- 3) With the second-order temperature compensation as described in Section "FUNCTION". See next section for typical operating curves.
- 4) The long-term stability is measured with non-soldered devices.

## **TEMPERATURE OUTPUT CHARACTERISTICS**

This temperature information is not required for most applications, but it is necessary to allow for temperature compensation of the output.

(VDD = 3.0 V unless noted otherwise)

Parameter	Conditions	Min	Тур	Max	Unit	Notes
Resolution		0.005	0.01	0.015	℃	
Accuracy	T = 20 °C	-0.8		0.8	℃	
	T = -40 + 85 ℃	-2		+6	℃	1
Maximum Error over Supply Voltage	VDD = 2.2 3.6 V	-0.2		+0.2	°C	2

## **NOTES**

- 1) With the second-order temperature compensation as described in Section "FUNCTION". See next section for typical operating curves.
- 2) At Ta = 25 ℃.



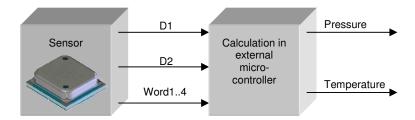
## **FUNCTION**

#### **GENERAL**

The MS5562 consists of a piezo-resistive sensor and a sensor interface IC. The main function of the MS5562 is to convert the uncompensated analogue output voltage from the piezo-resistive pressure sensor to a 16-bit digital value, as well as providing a 16-bit digital value for the temperature of the sensor.

Measured pressure (16-bit) "D1"
Measured temperature (16-bit) "D2"

As the output voltage of a pressure sensor is strongly dependent on temperature and process tolerances, it is necessary to compensate for these effects. This compensation procedure must be performed by software using an external microcontroller.



For both pressure and temperature measurement the same ADC is used (sigma delta converter):

- for the pressure measurement, the differential output voltage from the pressure sensor is converted
- for the temperature measurement, the sensor bridge resistor is sensed and converted

During both measurements the sensor will only be switched on for a very short time in order to reduce power consumption. As both, the bridge bias and the reference voltage for the ADC are derived from VDD, the digital output data is independent of the supply voltage.

## **FACTORY CALIBRATION**

Every module is individually factory calibrated at two temperatures and two pressures. As a result, 6 coefficients necessary to compensate for process variations and temperature variations are calculated and stored in the 64-bit PROM of each module. These 64-bit (partitioned into four words of 16-bit) must be read by the microcontroller software and used in the program converting D1 and D2 into compensated pressure and temperature values.

## PRESSURE AND TEMPERATURE MEASUREMENT

The sequence of reading pressure and temperature as well as of performing the software compensation is depicted in Fig. 3 and Fig. 5.

First Word1 to Word4 have to be read through the serial interface. This can be done once after reset of the microcontroller that interfaces to the MS5562. Next, the compensation coefficients C1 to C6 are extracted using bit-wise logical- and shift-operations (refer to Fig. 4 for the bit-pattern of Word1 to Word4).

For the pressure measurement, the microcontroller has to read the 16-bit values for pressure (D1) and temperature (D2) via the serial interface in a loop (for instance every second). Then, the compensated pressure is calculated out of D1, D2 and C1 to C6 according to the algorithm in Fig. 3 (possibly using quadratic temperature compensation according to Fig. 5). All calculations can be performed with signed 16-bit variables. Results of multiplications may be up to 32-bit long (+sign). In the flow according to Fig. 3 a division follows each



multiplication. This division can be performed by bit-wise shifting (divisors are to the power of 2). It is ensured that the results of these divisions are less than 65536 (16 bit).

For the timing of signals to read out Word1 to Word4, D1, and D2 please refer to the paragraph "Serial Interface".



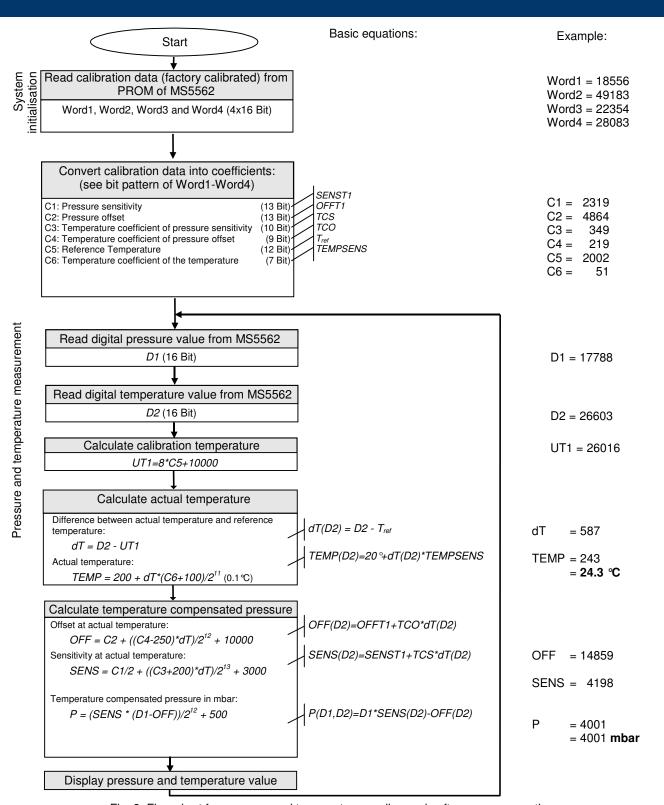


Fig. 3: Flow chart for pressure and temperature reading and software compensation

#### **NOTES**

- 1) Readings of D2 can be done less frequently, but the display will be less stable in this case.
- 2) For a stable display of 1 mbar resolution, it is recommended to display the average of 8 subsequent pressure values.



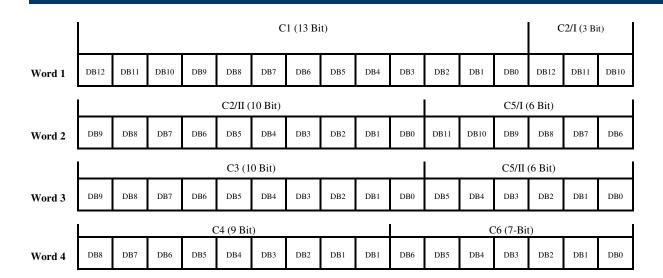


Fig. 4: Arrangement (Bit-pattern) of calibration data in Word1 to Word4

## SECOND-ORDER TEMPERATURE COMPENSATION

In order to obtain full temperature accuracy over the whole temperature range, it is recommended to compensate for the non-linearity of the output of the temperature sensor. This can be achieved by correcting the calculated temperature and pressure by a second order correction factor. The second-order factors are calculated as follows:

#### To be defined

Fig. 5: Flow chart for calculating the temperature and pressure to the optimum accuracy.



#### **SERIAL INTERFACE**

The MS5562 communicates with microprocessors and other digital systems via a 3-wire synchronous serial interface as shown in Fig. 1. The SCLK (Serial clock) signal initiates the communication and synchronizes the data transfer with each bit being sampled by the MS5562 on the rising edge of SCLK and each bit being sent by the MS5562 on the rising edge of SCLK. The data should thus be sampled by the microcontroller on the falling edge of SCLK and sent to the MS5562 with the falling edge of SCLK. The SCLK-signal is generated by the microprocessor's system. The digital data provided by the MS5562 on the DOUT pin is either the conversion result or the software calibration data. In addition, the signal DOUT (Data out) is also used to indicate the conversion status (conversion-ready signal, see below). The selection of the output data is done by sending the corresponding instruction on the pin DIN (Data input).

Following is a list of possible output data instructions:

Conversion start for pressure measurement and ADC-data-out	"D1"	(Figure 6a)
Conversion start for temperature measurement and ADC-data-out	"D2"	(Figure 6b)
Calibration data read-out sequence for Word1		(Figure 6c)
Calibration data read-out sequence for Word2		(Figure 6d)
Calibration data read-out sequence for Word3		(Figure 6c)
Calibration data read-out sequence for Word4		(Figure 6d)
RESET sequence		(Figure 6e)

Every communication starts with an instruction sequence at pin DIN. Fig. 6 shows the timing diagrams for the MS5562. The device does not need a 'Chip select' signal. Instead, there is a START sequence (3-bit high) before each SETUP sequence and STOP sequence (3-bit low) after each SETUP sequence. The SETUP sequence consists in 4-bit that select a reading of pressure, temperature or calibration data. In case of pressure-(D1) or temperature- (D2) reading the module acknowledges the start of a conversion by a low to high transition at pin DOUT during the last bit of the STOP sequence.

Two additional clocks at SCLK are required after the acknowledge signal. Then SCLK is to be held low by the microcontroller until a high to low transition on DOUT indicates the end of the conversion.

This signal can be used to create an interrupt in the microcontroller. The microcontroller may now read out the 16 bit word by giving another 17 clocks on the SLCK pin. It is possible to interrupt the data READOUT sequence with a hold of the SCLK signal. It is important to always read out the last conversion result before starting a new conversion.

The RESET sequence is special as the module in any state recognizes its unique pattern. By consequence, it can be used to restart if synchronization between the microcontroller and the MS5562 has been lost. This sequence is 21-bit long. The DOUT signal might change during that sequence (see Fig. 6e).

It is recommended to send the RESET sequence before each CONVERSION sequence to avoid hanging up the protocol permanently in case of electrical interference.

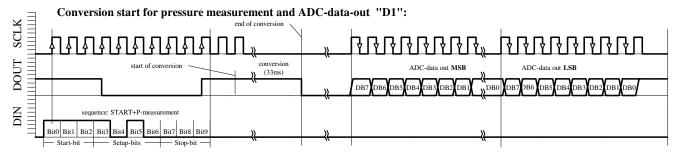


Fig. 6a: D1 ACQUISITION sequence



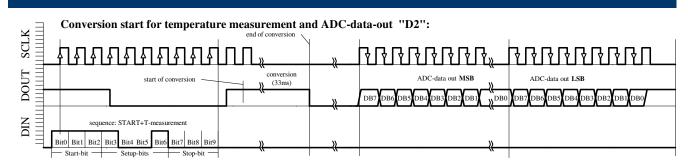


Fig. 6b: D2 ACQUISITION sequence

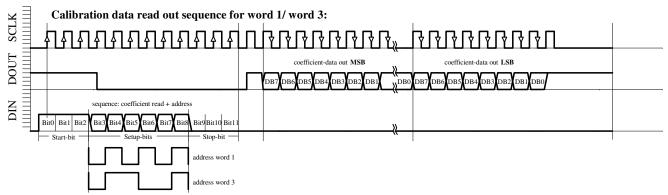


Fig. 6c: Word1, Word3 READING sequence

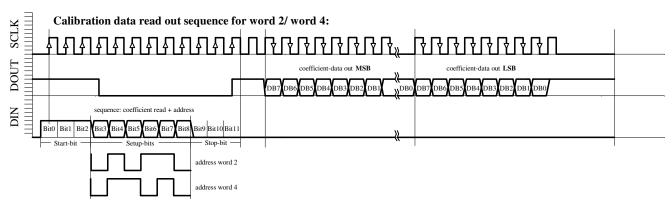


Fig. 6d: W2, W4 READING sequence

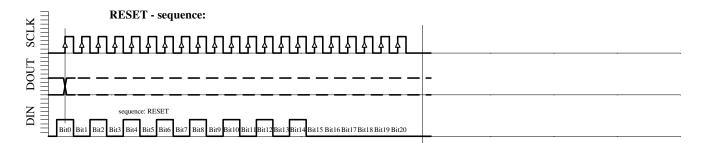


Fig. 6e: RESET sequence (21 bit)

# measurement S P E C I A L T I E S

## MS5562-C MICRO 14 bar MODULE

## **APPLICATION INFORMATION**

#### **GENERAL**

The advantage for this combination of a sensor with a directly adapted integrated circuit is to save other external components and to achieve very low power consumption. The main application field for this system includes portable devices with battery supply, but its high accuracy and resolution make it also suited for industrial and automotive applications. The possibility to compensate the sensor with software allows the user to adapt it to his particular application. Communication between the MS5562 and the widely available microcontrollers is realised over an easy-to-use 3-wire serial interface. Customers may select which microcontroller system to be used, and there are no specific standard interface cells required, which may be of interest for specially designed 4 Bitmicrocontroller applications.

#### **CALIBRATION**

The MS5562 is factory calibrated. The calibration data is stored inside the 64 bit PROM memory.

## **SOLDERING**

Please refer to the application note AN808 for all soldering issues.

## **HUMIDITY, WATER PROTECTION**

This module is designed for the integration into portable devices and sufficiently protected against humidity. A silicone gel for enhanced protection against humidity covers the membrane of the pressure transducer. The module must not be used directly for under water applications.

## LIGHT SENSITIVITY

The MS5562 is protected against sunlight by its metal cap. It is, however, important to note that the sensor may still be slightly sensitive to sunlight, especially to infrared light sources. This is due to the strong photo effect of silicon. As the effect is reversible there will be no damage, but the user has to take care that in the final product the sensor cannot be exposed to direct light during operation.

## **DECOUPLING CAPACITOR**

Particular care must be taken when connecting the device to power supply. A 47  $\mu$ F tantalum capacitor must be placed as close as possible of the MS5562's VDD pin. This capacitor will stabilize the power supply during data conversion and thus, provide the highest possible accuracy.



## **APPLICATION EXAMPLE: DIVING COMPUTER SYSTEM USING MS5562**

MS5562 is a circuit that can be used in connection with a microcontroller in diving computer applications. It is designed for low-voltage systems with a supply voltage of 3V, particularly in battery applications. The MS5562 is optimised for low current consumption as the AD-converter clock (MCLK) can use the 32.768 kHz frequency of a standard watch crystal, which is supplied in most portable watch systems.

For applications in altimeter systems Intersema can deliver a simple formula to calculate the altitude, based on a linear interpolation, where the number of interpolation points influences the accuracy of the formula.

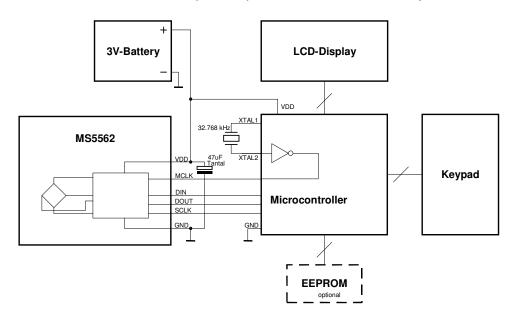
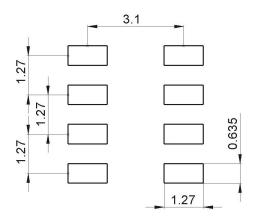


Figure 7: Demonstration of MS5562 in a mobile altimeter

## **RECOMMENDED PAD LAYOUT**

Pad layout for bottom side of MS5562 soldered onto printed circuit board.





## **DEVICE PACKAGE OUTLINES**

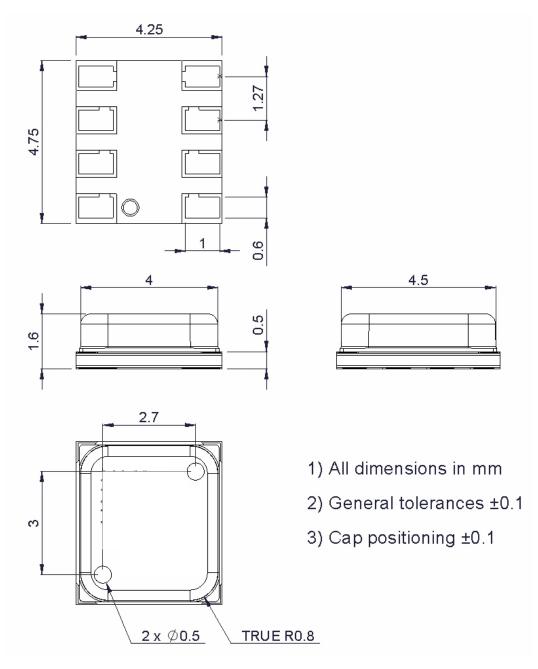


Fig. 8: Device package outlines of MS5562

# measurement S P E C I A L T I E S

## MS5562-C MICRO 14 bar MODULE

## **ASSEMBLY**

## **MOUNTING**

The MS5562 can be placed with automatic Pick & Place equipment using vacuum nozzles. It will not be damaged by the vacuum. Due to the low stress assembly the sensor does not show pressure hysteresis effects. It is important to solder all contact pads to avoid floating of the sensor during soldering. The pins PEN and PV shall be left open or connected to VDD. Do not connect the pins PEN and PV to GND!

## **CLEANING**

The MS5562 has been manufactured under cleanroom conditions. Each device has been inspected for the homogeneity and the cleanness of the silicone gel. It is therefore recommended to assemble the sensor under class 10'000 or better conditions. Should this not be possible, it is recommended to protect the sensor opening during assembly from entering particles and dust. To avoid cleaning of the PCB, solder paste of type "no-clean" shall be used. Cleaning might damage the sensor!

## **ESD PRECAUTIONS**

The electrical contacts except programming pads are protected against ESD up to 4 kV HBM (human body model). The MS5562 is shipped in antistatic transport boxes. Any test adapters or production transport boxes used during the assembly of the sensor shall be of an equivalent antistatic material.

## **ORDERING INFORMATION**

<b>Product Code</b>	Product	Art. No	Package	Comments
MS5562-C	Micro 14 bar module	325562000	Small Size SMD with metal lid	Module height 1.6 mm

## **FACTORY CONTACTS**

#### **NORTH AMERICA**

Measurement Specialties, Inc. 1000 Lucas Way Hampton, VA 23666 Tel: +1 800 555 1551

Fax: +1 757 766 4297 e-mail: <u>sales@meas-spec.com</u> Website: <u>www.meas-spec.com</u>

#### **EUROPE**

MEAS Switzerland SA Ch. Chapons-des-Prés 11 CH-2022 Bevaix Tel: +41 32 847 9550

Fax: + 41 32 847 9569 e-mail: <u>sales@intersema.ch</u> Website: <u>www.intersema.ch</u>

#### **ASIA**

Measurement Specialties (China), Ltd. F1.6-4D, Tian An Development Compound Shenzen, China 518048 Tel: +86 755 8330 1004

Fax: +86 755 8330 6797 e-mail: pfc.cs.asia@meas-spec.com Website: www.meas-spec-.com

The information in this sheet has been carefully reviewed and is believed to be accurate; however, no responsibility is assumed for inaccuracies. Furthermore, this information does not convey to the purchaser of such devices any license under the patent rights to the manufacturer. Measurement Specialties, Inc. reserves the right to make changes without further notice to any product herein. Measurement Specialties, Inc. makes no warranty, representation or guarantee regarding the suitability of its product for any particular purpose, nor does Measurement Specialties, Inc. assume any liability arising out of the application or use of any product or circuit and specifically disclaims any and all liability, including without limitation consequential or incidental damages. Typical parameters can and do vary in different applications. All operating parameters must be validated for each customer application by customer's technical experts. Measurement Specialties, Inc. does not convey any license under its patent rights nor the rights of others.